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ZVN4525E6

250V N-CHANNEL ENHANCEMENT MODE MOSFET

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)

For automotive applications requiring specific change

https://www.diodes.com/guality/product-definitions/

control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP

Package Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin Annealed over Copper Leadframe.

capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

Features and Benefits

Complementary P-Channel Type ZVP4525E6

UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020

Solderable per MIL-STD-202, Method 208 (3)

High Voltage Low On-Resistance Fast Switching Speed Low Threshold I ow Gate Drive

Mechanical Data

Package: SOT26

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Product Summary

BV _{DSS}	Max R _{DS(ON)}	Max I _D T _A = +25°C
250V	8.5Ω @ V _{GS} = 10V	230mA

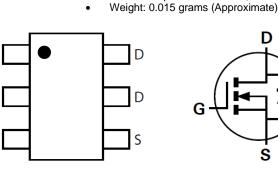
Description and Applications

This 250V enhancement mode N-channel MOSFET provides users with a competitive specification. It offers efficient power handling capability, high impedance and is free from thermal runaway and thermally induced secondary breakdowns. Applications benefiting from this device include a variety of telecom and general high-voltage circuits.

SOT89 and SOT223 versions are also available.

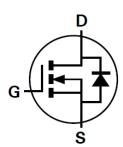
- Earth recall and dialing switches
- Electronic hook switches
- High-voltage power MOSFET drivers
- Telecom call routers
- Solid-state relays





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G



Top View

Pinout Top-View

Device Symbol

Ordering Information (Note 4)

Part Number	Part Number Package Reel Size (inch)		Tape Width (mm)	Packing		
Fait Number	Package	Reel Size (Inch)	Tape Width (mm)	Qty.	Carrier	
ZVN4525E6TA	SOT26	7	8	3000	Reel	
ZVN4525E6TC	SOT26	13	8	10,000	Reel	

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Notes:

Lead-free 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

			SOT N5 ●		YM Y or	= Date Co \overline{Y} = Year	Type Marł de Marking (ex: L = 20 h (ex: 4 = 7	1 24)				
Date Code Key Year	2015	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	C	-	L	M	N	P	R	S	T	U	V	W
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	250	V
Gate-Source Voltage			V _{GS}	±40	V
Continuous Drain Current	101	T _A = +25°C (Note 5)	١D	230	
	Vgs = 10V	T _A = +70°C (Note 5)		183	mA
Pulsed Drain Current (Note	7)		I _{DM}	1.44	А
Continuous Source Current (Body Diode)			ls	1.1	А
Pulsed Source Current (Body Diode)			Ism	1.44	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation at $T_A = +25^{\circ}C$ (Note 5)	PD	1.1	W
Linear Derating Factor	FD	8.8	mW/°C
Junction to Ambient (Note 5)	Reja	113	°C/W
Junction to Ambient (Note 6)	Reja	65	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	۵°

Notes: 5. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

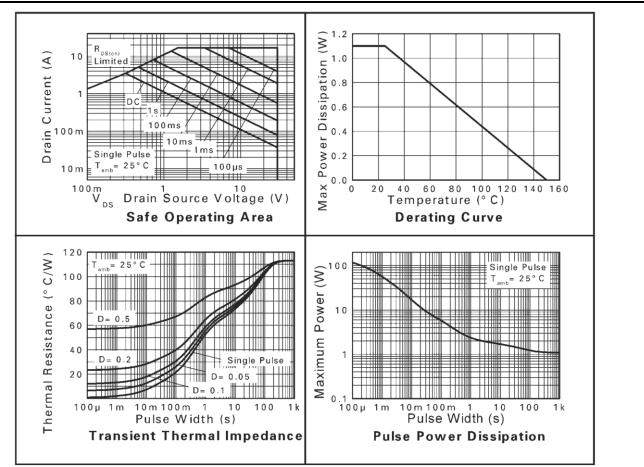
6. For a device surface mounted on FR4 PCB measured at t \leq 5 secs.

7. Repetitive rating - pulse width limited by maximum junction temperature. Refer to Transient Thermal.

NB High Voltage Applications

For high voltage applications, the appropriate industry sector guidelines should be considered with regards to voltage spacing between conductors.

Thermal Characteristics





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

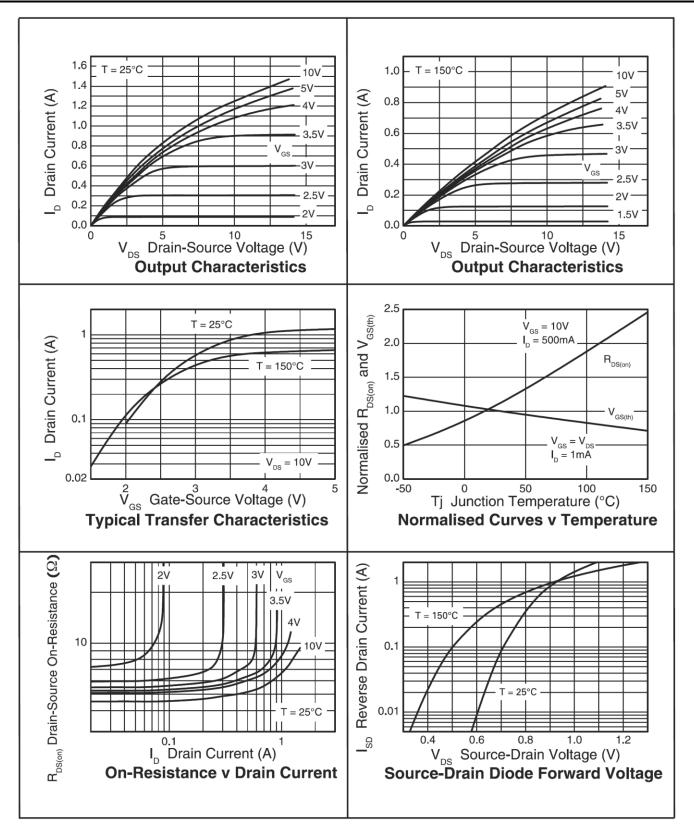
			-			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS				1		
Drain-Source Breakdown Voltage	BVDSS	250	285	—	V	$I_D = 1mA$, $V_{GS} = 0$
Zero Gate Voltage Drain Current	IDSS		35	500	nA	$V_{DS} = 250V, V_{GS} = 0$
Gate-Body Leakage	Igss		±1	100	nA	$V_{GS} = \pm 40V, V_{DS} = 0$
ON CHARACTERISTICS						
Gate-Source Threshold Voltage	VGS(th)	0.8	1.4	1.8	V	$I_D = 1mA$, $V_{DS} = V_{GS}$
			5.6	8.5		$V_{GS} = 10V, I_{D} = 500 \text{mA}$
Static Drain-Source On-State Resistance (Note 8)	R _{DS(ON)}	_	5.9	9.0	Ω	$V_{GS} = 4.5V, I_D = 360mA$
			6.4	9.5		$V_{GS} = 2.4V, I_D = 20mA$
Forward Transconductance (Note 10)	g fs	0.3	0.475	_	S	V _{DS} = 10V, I _D = 0.3A
Diode Forward Voltage (Note 8)	V _{SD}	—	_	0.97	V	T_J = +25°C, I_S = 360mA, V_{GS} = 0
DYNAMIC CHARACTERISTICS (Notes 9 & 10)						
Input Capacitance	Ciss	—	72	—	pF	
Output Capacitance	Coss	—	11		pF	[−] V _{DS} = 25V, V _{GS} = 0, − f = 1MHz
Reverse Transfer Capacitance	Crss	_	3.6	_	pF	
Total Gate Charge	Qg	_	2.6	3.65	nC	
Gate-Source Charge	Qgs	_	0.2	0.28	nC	$V_{GS} = 10V, V_{DS} = 25V,$
Gate-Drain Charge	Qgd	_	0.5	0.7	nC	$-I_D = 360 \text{mA}$ (refer to test circuit)
Reverse-Recovery Time (Note 10)	trr	_	186	260	ns	T _J = +25°C, I _F = 360A,
Reverse-Recovery Charge (Note 10)	Qrr	_	34	48	nC	di/dt = 100A/µs
Turn-On Delay Time	td(on)	_	1.25	_	ns	
Turn-On Rise Time	tr	_	1.7	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time	t _{d(off)}	_	11.40	_	ns	$I_D = 360 \text{mA}, R_G = 50\Omega$ (refer to test circuit)
Turn-Off Fall Time	tr	_	3.5	_	ns	

Notes:

8. Measured under pulsed conditions. Width = 300µs. Duty cycle ≤ 2%.
9. Switching characteristics are independent of operating junction temperature.
10. For design aid only, not subject to production testing.

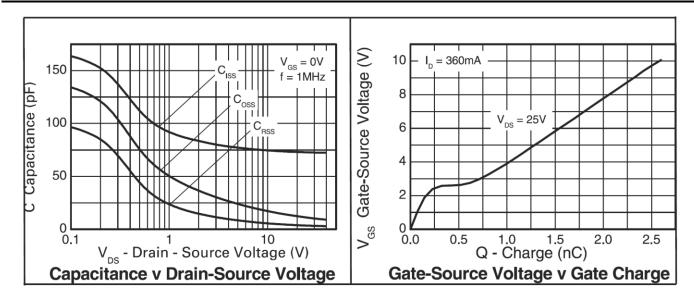


Typical Characteristics

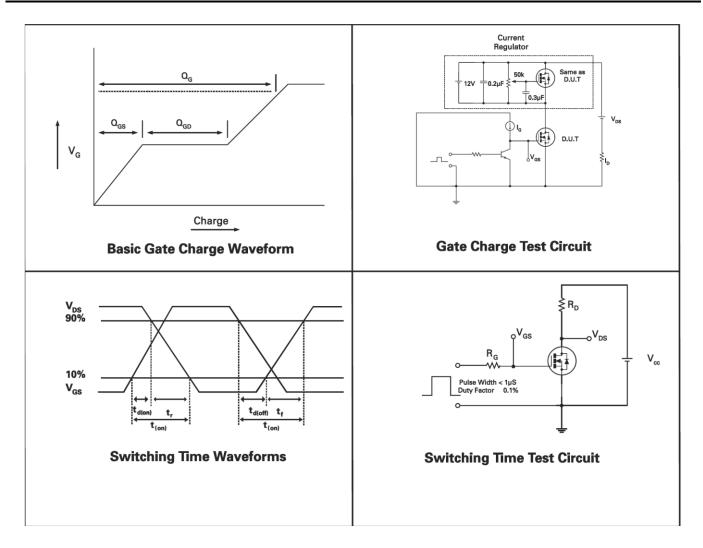




Typical Characteristics (continued)



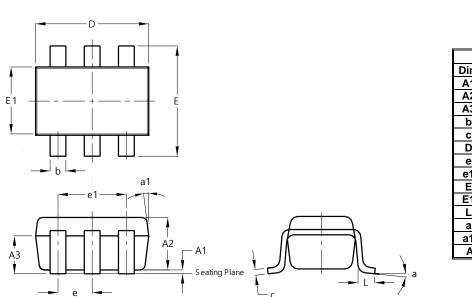
Test Circuits





Package Outline Dimensions

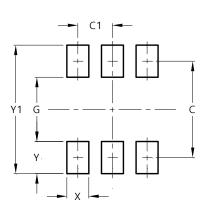
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT26						
Min	Max	Тур				
0.013	0.10	0.05				
1.00	1.30	1.10				
0.70	0.80	0.75				
0.35	0.50	0.38				
0.10	0.20	0.15				
2.90	3.10	3.00				
-	-	0.95				
-	-	1.90				
2.70	3.00	2.80				
1.50	1.70	1.60				
0.35	0.55	0.40				
-	-	8°				
-	-	7°				
Dimen	sions	in mm				
	Min 0.013 1.00 0.70 0.35 0.10 2.90 - 2.70 1.50 0.35 - - - - - - - - - - - - -	Min Max 0.013 0.10 1.00 1.30 0.70 0.80 0.35 0.50 0.10 0.20 2.90 3.10 - - 2.70 3.00 1.50 1.70				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO	T26
$\mathbf{v}\mathbf{v}$	

SOT26

Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Ŷ	0.80
Y1	3.20



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